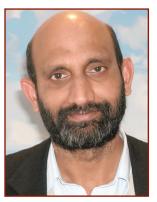


Paul E. Krajewski



Eduard Arzt



Chennupati Jagadish

Three TMS Members Selected for National Academy of Engineering

member news

Share the good news about your professional accomplishments! Contact Kaitlin Calva, JOM Magazine Managing Editor, at kcalva@tms.org. Please note that only news submitted by current TMS members will be considered.

TMS Members Elected to NAE

Congratulations are in order for three TMS members who were elected to the U.S. National Academy of Engineering (NAE) this year. Election to the NAE is among the highest professional distinctions for engineers and honors those who have made outstanding contributions to "engineering research, practice, or education, including, where appropriate, significant contributions to the engineering literature" and to "the pioneering of new and developing fields of technology, making major advancements in the traditional fields of engineering, or developing/implementing innovative approaches to engineering education."

The following TMS member will be inducted as one of 87 U.S. members in the NAE:

Paul E. Krajewski

Krajewski is the director, global research and development, at General Motors Co., in Warren, Michigan. He was elected "for development and implementation of lightweight automotive materials." A TMS member since 1993, Krajewski received the 2013 AIME Champion H. Matthewson Award and

was in the first class of TMS Brimacombe Medalists in 2012.

The following TMS members will be inducted as two of 18 international members in the NAE:

Eduard Arzt

Arzt, the chief executive officer and scientific director at INM-Leibniz Institute for New Materials of Saarland University in Saarbrücken, Germany, was elected "for research on mechanical properties and development of bio-inspired functional surfaces for medical adhesives and novel gripping systems." A longtime member of TMS, Arzt is the 2020 recipient of the TMS Morris Cohen Award.

Chennupati Jagadish

A distinguished professor of electronic materials engineering at the Australian National University in Canberra, Jagadish was elected "for contributions to nanotechnology for optoelectronic devices." He has been a TMS member since 2013 and is also a 2015 Fellow of the U.S. National Academy of Inventors.

The new class will be formally inducted during a ceremony at the NAE's annual meeting in Washington, D.C., on October 4, 2020.

In Memoriam: Nigel Ricketts

TMS extends its condolences to the family, friends, and colleagues of Nigel J. Ricketts, who passed away on June 29, 2019. A TMS member since 1992, he was actively involved in the Society's Aluminum Committee, serving as coorganizer of the Scandium Extraction and Use in Aluminum Alloys symposium at the TMS 2019 Annual Meeting & Exhibition.

Throughout his career, Ricketts focused on steelmaking, base metals pyrometallurgy and hydrometallurgy, base metal flotation, magnesium and aluminum metallurgy, gold processing, and exotic metals, like vanadium and scandium. Most recently, he worked as the vice president of project and market development at Scandium International until June 2018.

David Williams Awarded RMS Honorary Fellowship

Longtime TMS member and 1996 TMS Fellow David B. Williams was appointed Honorary Fellow by the Royal Microscopy Society (RMS). Williams, the Monte Ahuja Endowed Dean's Chair and Dean of the College of Engineering at The Ohio State University, was recognized for his pioneering work in developing analytical transmission electron microscopy (ATEM), as well as its applications to a broad range of materials. "Over the past 45 years his work has led to a new understanding of materials and microstructural evolution, including segregation, precipitation phenomena, phase diagrams, and phase transitions in metals and alloys," the RMS said of his appointment.

The distinction of Honorary Fellow is one of the most prestigious awards the society has to offer. The honors will be presented at the European Microscopy Congress 2020, to be held August 23–28, in Copenhagen, Denmark.



David B. Williams

TMS Welcomes New Members

The TMS Board of Directors approved professional membership for the following individuals at its February 2020 meeting. Please join us in congratulating and welcoming them to all the privileges and benefits of TMS membership.

Abbasi Shirsavar, Mehran; United States

Abdul Wahab, Mohammad Azizol; Malaysia

Abdullah, Aboubakr M.; Qatar University, Qatar

Adam, Hamish; Boreal Laser, Canada

Adedayo, Babatunde Adelowo; National Iron Ore Mining Company Limited, Nigeria

Ahmadi, Arezoo; RGQ, Iran

Ahnen, Violet M.; United States

Akhondi, Alireza; John R. Kieth, Australia

Akid, Robert; United Kingdom

Aliasghari, Hadi; Nano Shargh Abzar-e Toos Co., Iran

Aliof, Matt; United States

Allen, Brian; Dynamic System Inc. (Gleeble), United States

Allen, Harvey Pascoe; United Kingdom

Al-Shawi, Fadhil Abbas; United Kingdom

Altenbaugh, Derek; Robindale Energy Services, United States

Ambury, Rachael Fiona; United Kingdom

Anderson, Kevin; Brunswick-Mercury Marine, United States

Andrade, Marcio S.; IPEN, Brazil

Anstee, Richard Charles; Canada

Arai, Isao; Mitsubishi Materials, United States

Araneda, Eugenia; Chile

Aregawi, Wondwosen Abebe; University of Minnesota, United States

Asadikiya, Mohammad; Worcester Polytechnic Institute, United States

Baker, Lee; United Kingdom

Bansal, Anushka; United States

Barnes, Lee A.; United Kingdom

Basheer, Uday M.; United Kingdom

Bauerschlag, Nils; Hydro Aluminium Rolled Products GmbH, Germany

Bechly, Maximilian; University of Applied Sciences Stralsund, Germany

Bennett, Charles Andrew; United Kingdom

Bertherat, Marc; Constellium, Switzerland

Besson, Jacques; École des Mines, France

Bezrukikh, Aleksandr I.; Siberian Federal University, Russian Federation

Bhaskar, Pragna; Georgia Institute of Technology, United States

Bhattacharya, Sudip; 6K Inc., United States

Bidari, Ehsan; Iran

Bilotti, Emiliano; United Kingdom

Bin Norizan, Mohd Natashah; Universiti Malaysia Perlis, Malaysia

Bittner, Benjamin; MeKo Laser Material Processing, France

Blackledge, Jonathan; United Kingdom

Blade, Lee; United Kingdom

Boff, James Charles; United Kingdom

Bojorquez, Francisco; Univerisdad de Sonora, Mexico

Boon, Jonathan Charles; United Kingdom

Boulaki, Foteini; United Kingdom

Bounou, Aikaterini; United Kingdom

Brandwood, Arthur; Australia

Breach, Christopher David; United Kingdom

Brismalein, David; Aluminium Dunkergue, France

Brown, Keith A.; Boston University, United States

Buller, Dane; United Kingdom

Buonocome, Giuseppe; United Kingdom

Burlatsky, Sergei; United Technologies Research Center, United States

Burton, Trevor; United Kingdom

Butala, Megan M.; University of Florida. United States

Buys, Ockert; United Kingdom

- Caine, Marcus; United Kingdom
- Cairns, Daniel Lee; United Kingdom
- Cam, Gurel; Iskenderun Technical University, Turkey
- Campbell, David Stanley; United Kingdom
- Campbell, Douglas James; United Kingdom
- Campbell, Sylvia; United Kingdom
- Carruthers, Alex William; University of Manchester, United Kingdom
- Casali, Dick; Intel Corp., United States
- Chakraborty, Kalyan Kumar; India
- Chakraborty, Madhusudan; Adamas University, India
- Chalmers, Frances Jane; United Kingdom
- Chan, Helen M.; Lehigh University, United States
- Channer, Akeel; NSWCCD, United States
- Chen, Kongtao; University of Pennsylvania, United States
- Chen, Peng; Texas A&M University, United States
- Chen, Yang-yuan D.; Institute of Physics, Academia Sinica, Taiwan
- Cheng, Lin; University of Pittsburgh, United States
- Chen-Wiegart, Yu-chen Karen; Stony Brook University/Brookhaven National Laboratory, United States
- Chernetskiy, Ivan Vladimirovich; Ural Federal University, Russian Federation
- Chico, Jonathan P.; Sandvik Coromant, Sweden
- Choi, Sun; KIST, South Korea
- Chowdhury, Sugata; National Institute of Standards and Technology, United States
- Christensen, Steffen; Oman
- Christopherson, Rhea; Materion, United States
- Chui, Yin Tak; United Kingdom

- Chung, Sheng-Heng; National Cheng Kung University, Taiwan
- Clark, Julian Peter; United Kingdom
- Clemmey, Richard Henry; United Kingdom
- Co, Noelle C.; Blade Energy Partners, United States
- Coley, Michael Delroy; University of the West Indies, Jamaica
- Conway, Patrick; Jönköping University, Sweden
- Cooper, Sarosh Sam; India
- Cordill, Craig; Wagstaff, United States
- Cortes, Pedro; Youngstown State University, United States
- Costello, Kenneth J.; High Temp Measurement LLC, United States
- Cote, Patrice; Rio Tinto Aluminium, Canada
- Coury, Francisco Gil; Universidade Federal de São Carlos, Brazil
- Couzinie, Jean-Philippe; Université Paris Est. France
- Craig, Thomas Orr; United Kingdom
- Cumings, John; University of Maryland, United States
- Cunha, Jose; Alumar, Brazil
- Dahlstrom, James; Gopher Resource, United States
- Das, Hrishikesh; Pacific Northwest National Laboratory, United States
- Davies, Peter J.; Germany
- De Geuser, Frederic; Simap Université Grenoble Alpes, France
- De Palma, Alex C.; Univeristy of Texas Austin, United States
- Dear, Felicity F.; Imperial College London, United Kingdom
- Demetriou, Demetrios Haralambos; United Kingdom
- Depan, Dilip; University of Louisianna Lafayette, United States
- Deschênes, Jean-Michaël; Laserax, Canada
- Devendhar Singh, Sanjay Kumar; Virginia Polytechnic Institute and State University, United States

- Dienn, Henry; High-End Ltd., Japan
- Dixit, Vikas; Intel Corp., United States
- Doshi, Aakash; Almex USA Inc., United States
- Douch, Colin J.: New Zealand
- Dryden, Daniel M.; United States
- Du, Chuanming; Tohoku University, Japan
- Dykhuis, Andrew; United States
- El-Atwani, Osman; Los Alamos National Laboratory, United States
- Eliaz, Noam; Tel-Aviv University, Israel
- Elliot, Christopher Neil; United Kingdom
- Ellis, Elizabeth A.I.; Oak Ridge National Laboratory, United States
- Emami Tabrizi, Isa; Sabanci University Orta Mahalle Tuzla, Turkey
- Emdadi, Aliakbar; Germany
- Eskil, Murat; Aksaray University, Turkey
- Failla, David; Puget Sound Naval Shipyard, United States
- Falconer, James Robert; United Kingdom
- Fan, Zhe; Oak Ridge National Laboratory, United States
- Fasoro, Abiodun; United States
- Fayyad, Eman M.; Qatar University, Qatar
- Fernandez-Silva, Beatriz; University of Sheffield, United Kingdom
- Field, Kevin; University of Michigan, United States
- Finstad, Terje G.; University of Oslo, Norway
- Fleming, Thomas John; Ireland
- Flowers, Patrick; Made In Space Inc., United States
- Foster, Samuel Harry; United Kingdom
- Fradet, Claude; Equibras, Canada

- Frankel, Gerald S.; The Ohio State University, United States
- Fraser, Alex; Laserax Inc., Canada
- Fukunaka, Yasuhiro; Kyoto University, Japan
- Gambone, Justin J.; Georgia Institute of Technology, United States
- Ganjkhanlou, Yadolah; University of Turin, Italy
- Gao, Xu; Tohoku University, Japan
- Gao, Youping; Castheon Inc., United States
- Gao, Ziteng; United Kingdom
- Geiss, Roy; Colorado State University, United States
- Genin, Xavier; Solios Carbone, France
- Gentils, Aurelie; Université Paris-Saclay, France
- Ghods, Masoud; Middle East Technical University, Turkey
- Ghosh, Dipankar; Old Dominion University, United States
- Giegerich, Larry Joseph; Canada
- Gifford, Robert David; United Kingdom
- Glowacka, Angelika; United Kingdom
- Goken, Mathias; Friedrich-Alexander-University Erlangen-Nürnberg, Germany
- Gomez-Alvarez, Agustin; Univerisdad de Sonora, Mexico
- Gopalan, Prashanth; Univeristy of Utah, United States
- Gorain, Barun K.; Ore2Metal Inc., Canada
- Goshi, Takuya; Denso International America Inc., United States
- Greenwood, Sarah Catherine; United Kingdom
- Griffin, Martin Stephen; United Kingdom
- Groves, David; United Kingdom
- Gu, Geun Ho; KAIST, South Korea
- Guda Vishnu, Karthik; Purdue University, United States

- Guiglionda, Gilles; Constellium CRV, France
- Gurin, Elizabeth A.; Becton Dickinson, United States
- Hackett, Benjamin; Texas A&M University, United States
- Han, Seung Min; KAIST, South Korea
- Hanby, Ian R.; New Caledonia
- Harrington, Sean D.; United States
- Harrington, Tyler; Oerlikon Metco, United States
- Harrison, Marcus Elliot; United States
- Hassan, Mohammad K.; Qatar University, Qatar
- He, Jianhong; Oerlikon Metco, United States
- He, Jianjun; China
- Heidarzadeh, Akbar; Shahid Madani University, Iran
- Henshaw, David Cristopher; United Kingdom
- Heo, Jungho; LS-Nikko Copper Inc., South Korea
- Heydarinia, Ali; Iran
- Hooshmand, Nasrin; Georgia Institute of Technology, United States
- Hoover, Brian; Advanced Optical Technologies, United States
- Horn, Christopher; Ft. Wayne Metals Research/AMD, United States
- Horrocks, Philip J.; United Kingdom
- Hou, Wenyan; Central South University, China
- Howard, Gary W.; Safety and Forensic Engineering, Canada
- Howe, Tmothy Rowland; United Kingdom
- Hughes, Ian Gwyn; United Kingdom
- Hunter, Graham C.; United Kingdom
- Hunter, Luke William; United Kingdom
- Igbafen, Akure Ohiomomo; Federal University of Technology, Nigeria
- Ikeda, Satoshi; Nippon Light Metal Company Ltd., Japan

- Isherwood, Patrick James M.; United Kingdom
- Jacobson, Peter C.; Questek Innovations, United States
- Jagannadham, Kasichainula; North Carolina State University, United States
- Jahn, Matthias; University of Applied Sciences Stralsund, Germany
- James, Richard; United Kingdom
- Jamieson, Andrew; Navair, United States
- Jermy, C A; United Kingdom
- Jiao, Handong; Beijing Institute of Technology, China
- Johnstone, James; United Kingdom
- Jones, Nicholas G.; University of Cambridge, United Kingdom
- Jones, Selwyn John Lloyd; United Kingdom
- Joseph, David; United Kingdom
- Joseph, Jithin; Deakin University, Australia
- Jublot-Leclerc, Stephanie; JANNuS -Université Paris-Saclay, France
- Juwhari, Hassan; University of Jordan, Jordan
- Kafexhiu, Fevzi; Institute of Metals and Technology, Slovenia
- Kaligotla, Anand; Aludyne, United States
- Kalra, Anisha; Indian Institute of Science Bangalore, India
- Kantner, Chris; QuesTek Innovations, United States
- Kartashov, Vadim V.; Ural Federal University, Russian Federation
- Kawasaki, Megumi; Oregon State University, United States
- Khalajhedayati, Amirhossein; TowerJazz, United States
- Khan, Kamruzzaman; University of Michigan Ann Arbor, United States
- Khoshghadam-Pireyousefan, Mohammad; Fardanegar, Iran

- Khosla, Nathan; United States
- Kim, Sang-shik; Gyeongsang National University, South Korea
- King, William L.; AK Steel Corp., United States
- Kishore, Krishna Mugada; Indian Institute of Technology Delhi, India
- Kocaefe, Duygu; University of Quebec at Chicoutimi, Canada
- Kowathanakul, Nopasorn; United States
- Krings, Daniel; Hydro Aluminium Rolled Products, Germany
- Krishna, Athith; University of California, Santa Barbara, United States
- Krishna, Vamsi; University of Chicago, United States
- Kucza, Nikole J.; GE Global Research, United States
- Kuhn, Erik; National Renewable Energy Laboratory, United States
- Kuiken, Hilbrand; Quantillion Technologies, Netherlands
- Kumar, M. Arul; Los Alamos National Laboratory, United States
- Kurosaki, Ken; Osaka University, Japan
- Lacey, Jeffery; Idaho National Laboratory, United States
- Lahlouh, Bashar; University of Jordan, Jordan
- Lam, Marcus Chunwai; MCAM, Monash University, Australia
- Langille, Michael; Constellium Technology Center (C-TEC), France
- Lannoy, Nate; United States
- Lanzarotta, George; Kammerath & Weiss, United States
- Lau, Yang Hao; Institute of High Performance Computing, Singapore
- Launiere, Cari; Argonne National Laboratory, United States
- Lazarescu, Lucian; Technical University of Cluj-Napoca, Romania

- Lee, Je In; Pusan National University, South Korea
- Lee, Min-Ha; KITECH, South Korea
- Leung, Chu Lun Alex; United Kingdom
- Levine, Lyle E.; National Institute of Standards and Technology, United States
- Li, Shunping, Apple, United States
- Li, Xiangguo; University of California, San Diego, United States
- Liao, Michael E.; University of California, Los Angeles, United States
- Lim, Chao Voon Samuel; Monash University, Australia
- Lips, Andor; Netherlands
- Liu, Jing; University of Alberta, Canada
- Liu, Xianbin; Singapore
- Long, Gerard Christopher; United Kingdom
- Longwell, David Jame; United Kingdom
- Ludwig, Alfred; Ruhr-University Bochum, Germany
- Lukac, Frantisek; Institute of Plasma Physics of the Czech Academy of Sciences, Czech Republic
- Luo, Yan; University of Science & Technology Beijing, China
- Lyle, Luke A.M.; Carnegie Mellon University, United States
- Ma, Ke; University of Connecticut, United States
- Mackie, David Murray; United Kingdom
- Macklin, Stephen Robert; Australia
- Maddox, Jennie C.; Mississippi State University, United States
- Mahieu, Pierre; Solios Carbone, France
- Makepeace, Jeremy D.; United Kingdom
- Martin Da Silva, Iva Luisa; United Kingdom
- Marvel, Christopher J.; Lehigh University, United States
- Maxwell, Austin; Alcoa, Australia
- Mayandi, Jeyanthinath; SMN, Department of Physics, Norway
- McGinnity, Brian T.; United Kingdom

- McGregor, Ronald; Canada
- McLaughlin, Paul; United Kingdom
- McQueen, Fraser Wilson; United Kingdom
- Meadley, Philip Frank; Singapore
- Meddeb, Sami; Grenoble Institute of Technology, France
- Mei, Jun; Queensland University of Technology, Australia
- Mendieta, Marla J.; Ormco, United States
- Mendoza-Cruz, Ruben; University of Texas at San Antonio, United States
- Menze, Roman; MeKo Laser Material Processing, Germany
- Mermet, Stéphane; Liberty Aluminium Dunkerque, France
- Mhay, Amandeep Singh; United Kingdom
- Miao, Jiashi; The Ohio State University, United States
- Mihalop, Owen Daniel; United Kingdom
- Milhet, Xavier; Prime Institute CNRS ENSMA, France
- Millar, Dean Lee; Canada
- Mirabedini, Pegah S.; University of California, Riverside, United States
- Mirak, Mohammad; Behine Sanjesh Pars Alma, Iran
- Mitkova, Maria; Boise State University, United States
- Mohaghegh Moein, Alireza; Iran
- Mohammadzadeh, Ahad; Iran
- Molaei, Fatemeh; University of Arizona, United States
- Mollah, Shahab; University of South Carolina, United States
- Monaghan, Elizabeth A.; GE Power, United States
- Mondal, Kunal; Idaho National Laboratory, United States
- Moon, Yun Sung; South Korea
- Moore, Richie; United Kingdom

- Moravcik, Igor; Brno University of Technology, Czech Republic
- Moseley, Steven Glyn; Liechtenstein
- Moss, Allan; Canada
- Mukhtarov, Shamil Khamzaevich; Institute for Metals Superplasticity Problems, Russian Federation
- Mulheron, Michael John; United Kingdom
- Munoz, Jorge A.; University of Texas at El Paso, United States
- Muta, Hiroaki; Osaka University, Japan
- Mutreja, Isha; University of Minnesota, United States
- Na, Young-Sang; Korea Institute of Materials Science, South Korea
- Naeimi Panjaki, Alireza Ali; Japan
- Naji, Hojjat; I.T. Forging Co., Iran
- Nam, SungWoo; University of Illinois Urbana-Champaign, United States
- Nasiri Khalil Abad, Sajjad; Sahand University of Technology, Iran
- Nasouri, Reza; University of Texas at San Antonio, United States
- Nelaturu, Phalgun; University of Wisconsin, United States
- Nicholls, Peter; United Kingdom
- Niitsu Campo, Kaio; Unicamp, Brazil
- Nish, John; Welman Dynamics, United States
- Nordlund, Kai; University of Helsinki, Finland
- Oba, Satoshi; Nippon Light Metal Company Ltd., Japan
- O'Connor, Christopher; United Kingdom
- Ogle, Richard; United Kingdom
- Oh, Hyunseok; Massachusetts Institute of Technology, United States
- O'Hara, Dante J.; Naval Research Laboratory, United States
- Ohishi, Yuji; Osaka University, Japan
- Orr, Jessica; University of Dayton Research Institute, United States

- Osei-Agyemang, Eric; Lehigh University, United States
- Overman, Nicole R.; Pacific Northwest National Laboratory, United States
- Owusu-Konadu, Barbara M.; BOK Engineering Consulting Services, Ghana
- Ozagir, Ozcan; United Kingdom
- Pandolfelli, Victor; Alcoa Laboratory, Federal University of Sao Carlos, Brazil
- Papaj, Ewa; United Kingdom
- Papakonstantinou, Konstantinos; United Kingdom
- Papanikolaou, Michail; Cranfield University, United Kingdom
- Parisi, Cristian; United Kingdom
- Park, Jonghyun; Missouri University of Science and Technology, United States
- Park, Joo Hyun; Hanyang University, South Korea
- Park, Joon Young; Harvard University, United States
- Park, Yongmin; KG Dongbu Steel, South Korea
- Parra, Roberto A.; Universidad de Concepcion, Chile
- Parra-Sanchez, Victor Roberto; Universidad de Concepcion, Chile
- Pateras, Anastasios; Los Alamos National Laboratory, United States
- Pavlina, Erik J.; AK Steel Corporation, United States
- Pearson, Alastair Scott; United Kingdom
- Pecharsky, Vitalij K.; Iowa State University, United States
- Pedroli, Herve; Aluminium Dunkerque, France
- Perry, Carole; Nottingham Trent University, United Kingdom
- Phanopoulos, Christopher; Belgium
- Pickering, Ed; University of Manchester, United Kingdom
- Pierson, Ed; Lockheed Martin Space, United States
- Ping, Xue; Jianghan University, China

- Ponce, Arturo; University of Texas at San Antonio, United States
- Popplewell, Guy; United Kingdom
- Porter, Matthew; United Kingdom
- Potter, Michael; RJ Lee Group, United States
- Potter, Tara Jessica; United Kingdom
- Pouladi, Sara; University of Houston, United States
- Pouranvari, Majid; Sharif University of Technology, Iran
- Pramanik, Brahmananda; Montana Tech, United States
- Prasetyo, Erik; Indonesian Institute of Sciences, Indonesia
- Priddy, Matthew W.; Mississippi State University, United States
- Primeau, Pierre J.A.; Golder Associates Ltd., Canada
- Qu, Jun; Oak Ridge National Laboratory, United States
- Raabe, Dierk R.; Max-Planck Institute, Germany
- Rack, Alexander; European Synchrotron Radiation Facility, France
- Ramasagara Nagarajan, Varun; Altair ProductDesign, United States
- Rao, Apparao M.; Clemson University, United States
- Rashad, Mohamed; Central Metallurgical Research and Development Institute, Egypt
- Rashed, Md Golam; Australia
- Rasooli, Novin; University of Tehran, Iran
- Rathkanthiwar, Shashwat; Indian Institute of Science Bangalore, India
- Rawal, Suraj P.; Lockheed Martin Space, United States
- Ray, Atish K.; Novelis Inc., United States
- Raymond, Paul; United Kingdom
- Razmi, Jafar; Arizona State University, United States

- Rees, David Tien; University College London, United Kingdom
- Ren, Qiang; University of Science and Technology Beijing, China
- Rhinehart, Katherine; United States
- Richard, Gerald; Magma Foundry Technologies Inc., United States
- Roma, Guido; CEA, France
- Rosefort, Marcel; Trimet Aluminium SE, Germany
- Roy, Sougata; Oak Ridge National Laboratory, United States
- Sabarudin, Ahmad; Malaysia
- Sabeti Monfared, Ahad; Iran
- Sadawy, Mosaad Mohamad; Al-Azhar University, Egypt
- Sadeghi, Nima; Sahand University of Technology, Iran
- Salas Mula, Daniel; Texas A&M University, United States
- Sanchez-Corrales, Victor M.; University of Sonora, Mexico
- Sandnes, Espen; Norwegian University of Science and Technology, Norway
- Sarkar, Soumalya; United Technology Research Center, United States
- Schaffer, Jeremy; Fort Wayne Metals, United States
- Scheller, Piotr R.; TU Begakademie Freiberg, Germany
- Schellert, Steven; Universitat Siegen, Germany
- Schliephake, Daniel; Monash Centre for Additive Manufacturing, Australia
- Schofield, Timothy Robert; United Kingdom
- Scholtz, Juliane; The University of Michigan, United States
- Schrefl, Thomas; Danube University Krems, Austria
- Schriner, Doug; North American Stainless, United States

- Schuck, Christopher F.; University of Delaware, United States
- Schulz, Wencke; Bundesanstalt fur Materialforschung und -prufung, Germany
- Scott, James; United Kingdom
- Seetharaman, Sankaranarayanan; ANSYS, India
- Sengupta, Debasis; United States
- Shakoor, Abdul; Qatar University, Qatar
- Shamlaye, Karl; Deakin University, Australia
- Shapiro, Alexander E.; Titanium Brazing Inc., United States
- Shellam, Richard; United Kingdom
- Shen, Xian Chun; CITIC International Cooperation Co. Ltd., China
- Shepherd, Nigel; University of North Texas, United States
- Sherman, Andrew J.; Powdermet Inc./ Terves Inc., United States
- Shibayama, Atsushi; Akita University, Japan
- Shimokawa, Tomotsugu; Kanazawa University, Japan
- Shin, Seungha; University of Tennessee, United States
- Shinozaki, Maya; China
- Shokri, Nayer; Sahand University of Technology, Iran
- Shun, Tao-Tsung; Feng Chia University, Taiwan
- Singh, Ankit; Welspun Corp. Ltd., India
- Singh, Harminder; Guru Nanak Dev University, India
- Sismondi, Shawn; United Kingdom
- Sliem, Mostafa Hussien; Qatar University, Qatar
- Smith, David John; United Kingdom
- Softly, Tilly; United Kingdom
- Spark, Caroline; United Kingdom
- Srinivasan, Srilok; Argonne National Laboratory, United States

- Stamboulis, Artemis; University of Birmingham, United Kingdom
- Stanley, Ashlynn M.; NAVAIR, United States
- Steglich, Jan; TRIMET Aluminium SE, Germany
- Steinbach, Sonja; DLR, Germany
- Stephens, Alan; United Kingdom
- Stevens, Wayne; United Kingdom
- Strawbridge, Anna; United Kingdom
- Su, Yanqing; University of California, Santa Barbara, United States
- Sun, Weiping; Nucor Corporation, United States
- Sutton, Yvonne; United Kingdom
- Szczepanski, Christopher; Special Metals Corp., United States
- Taghavimehr, Mehrnoosh; Iowa State University, United States
- Talapatra, Anjana Anu; Los Alamos National Laboratory, United States
- Tan, Pengfu; Glencore, Switzerland
- Tang, Fengzai; University of Warrick, United Kingdom
- Tang, Wei; Ames Laboratories, United States
- Tariq, Hanan Abureh; Qatar University, Qatar
- Taylor, Justin Paul; Hong Kong
- Thompson, Vicki; Idaho National Laboratory, United States
- Todoroki, Hidekazu; Japan
- Toh, Qiuvi; United Kingdom
- Tomlinson, Sarah Louise; United Kingdom
- Tong, Jianhua; Clemson University, United States
- Torres, Jonathan; Bucknell University, United States
- Torres Arango, Maria; Brookhaven National Laboratory, United States

- Trevino, Diana A.; Worley, United States
- Trivedi, Pankaj B.; Booz Allen Hamilton, United States
- Trotter, Carolyn; BlueScope Steel Ltd., Australia
- Tsai, Ming-Hung; National Chung Hsing University, Taiwan
- Ueda, Shigeru; Tohoku University, Japan
- Ulrich, Tashiema L.; United States
- Unnikrishnan, Vinu; West Texas A&M University, United States
- Uwidia, Ita E.; University of Benin, Nigeria
- verma, Narendra Kumar; India
- Walsh, Brian; United Kingdom
- Walther, Frank; TU Dortmund University, Germany
- Wang, Kang; University of Virginia, United States
- Wang, Liancheng; Central South University, China
- Wang, Xin; University of California, Irvine, United States
- Wang, Yan; University of Nevada Reno, United States
- Wang, Yongjie; University of California, Berkeley, United States
- Wang, Yuechen; Nano and Advanced Materials Institute Limited, Hong Kong
- Ward, Al; United Kingdom
- Ward, Richard Wiltshire; United Kingdom
- Waterton, Michael; United States

- Watson, Frank; Safe Labs, United States
- Wen, Wei; ATI Specialty Materials, United States
- Werner, Andreas; United Kingdom
- Weston, Nicholas Samuel; University of Sheffield, United Kingdom
- Whitaker, Iain Robert; United Kingdom
- Whiteman, Dean; Alcoa, Australia
- Williams, Adrienne D.; ADee Technologies LLC, United States
- Williams, Maureen; National Institute of Standards and Technology, United States
- Williams, Nigel R.; United Kingdom
- Wilson, Orla; John Hopkins University, United States
- Wilson, Paul; Boeing, United States
- Wint, Natalie; United Kingdom
- Winter, Thomas; Naval Nuclear Laboratory, United States
- Wolff, Sarah J.; Texas A&M University, United States
- Wolfrum, Ed; National Renewable Energy Laboratory, United States
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